

SEMICONDUCTOR

FNB41060 Motion SPM[®] 45 Series

Features

- UL Certified No. E209204 (UL1557)
- 600 V 10 A 3-Phase IGBT Inverter with Integral Gate Drivers and Protection
- Low Thermal Resistance Using Ceramic Substrate
- · Low-Loss, Short-Circuit Rated IGBTs
- Built-In Bootstrap Diodes and Dedicated Vs Pins Simplify PCB Layout
- Built-In NTC Thermistor for Temperature Monitoring
- Separate Open-Emitter Pins from Low-Side IGBTs for Three-Phase Current Sensing
- Single-Grounded Power Supply
- Isolation Rating: 2000 V_{rms} / min.

Applications

• Motion Control - Home Appliance / Industrial Motor

Related Resources

- <u>AN-9070 Motion SPM® 45 Series Users Guide</u>
- <u>AN-9071 Motion SPM® 45 Series Thermal Perfor-</u> mance Information
- <u>AN-9072 Motion SPM® 45 Series Mounting Guidance</u>
- <u>RD-344 Reference Design (Three Shunt Solution)</u>
- RD-345 Reference Design (One Shunt Solution)

General Description

FNB41060 is a Motion SPM[®] 45 module providing a fully-featured, high-performance inverter output stage for AC Induction, BLDC, and PMSM motors. These modules integrate optimized gate drive of the built-in IGBTs to minimize EMI and losses, while also providing multiple on-module protection features including under-voltage lockouts, over-current shutdown, thermal monitoring, and fault reporting. The built-in, high-speed HVIC requires only a single supply voltage and translates the incoming logic-level gate inputs to the high-voltage, high-current drive signals required to properly drive the module's robust short-circuit-rated IGBTs. Separate negative IGBT terminals are available for each phase to support the widest variety of control algorithms.



Figure 1. Package Overview

Package Marking and Ordering Information

Device	Device Marking	Package	Packing Type	Quantity
FNB41060	FNB41060	SPMAA-A26	Rail	12

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January 2014

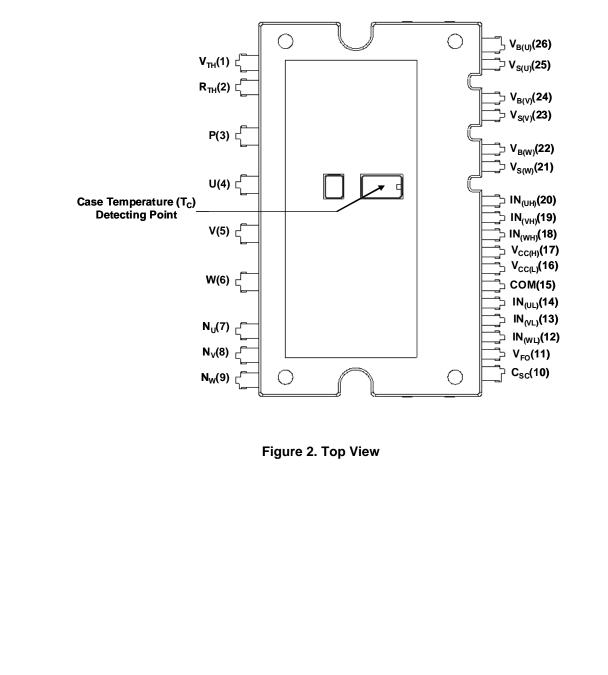
Integrated Power Functions

• 600 V - 10 A IGBT inverter for three-phase DC / AC power conversion (please refer to Figure 3)

Integrated Drive, Protection, and System Control Functions

- For inverter high-side IGBTs: gate drive circuit, high-voltage isolated high-speed level shifting control circuit Under-Voltage Lock-Out (UVLO) protection
- Fault signaling: corresponding to UVLO (low-side supply) and SC faults
- Input interface: active-HIGH interface, works with 3.3 / 5 V logic, Schmitt trigger input

Pin Configuration



FNB41060	
Motion	
SPM®	
45 Series	

Pin Number	Pin Name	Pin Description
1	V _{TH}	Thermistor Bias Voltage
2	R _{TH}	Series Resistor for the Use of Thermistor (Temperature Detection)
3	Р	Positive DC-Link Input
4	U	Output for U-Phase
5	V	Output for V-Phase
6	W	Output for W-Phase
7	NU	Negative DC-Link Input for U-Phase
8	N _V	Negative DC-Link Input for V-Phase
9	N _W	Negative DC-Link Input for W-Phase
10	C _{SC}	Capacitor (Low-Pass Filter) for Short-circuit Current Detection Input
11	V _{FO}	Fault Output
12	IN _(WL)	Signal Input for Low-Side W-Phase
13	IN _(VL)	Signal Input for Low-Side V-Phase
14	IN _(UL)	Signal Input for Low-Side U-Phase
15	СОМ	Common Supply Ground
16	V _{CC(L)}	Low-Side Common Bias Voltage for IC and IGBTs Driving
17	V _{CC(H)}	High-Side Common Bias Voltage for IC and IGBTs Driving
18	IN _(WH)	Signal Input for High-Side W-Phase
19	IN _(VH)	Signal Input for High-Side V-Phase
20	IN _(UH)	Signal Input for High-Side U-Phase
21	V _{S(W)}	High-Side Bias Voltage Ground for W-Phase IGBT Driving
22	V _{B(W)}	High-Side Bias Voltage for W-Phase IGBT Driving
23	V _{S(V)}	High-Side Bias Voltage Ground for V-Phase IGBT Driving
24	V _{B(V)}	High-Side Bias Voltage for V-Phase IGBT Driving
25	V _{S(U)}	High-Side Bias Voltage Ground for U-Phase IGBT Driving
26	V _{B(U)}	High-Side Bias Voltage for U-Phase IGBT Driving

Internal Equivalent Circuit and Input/Output Pins

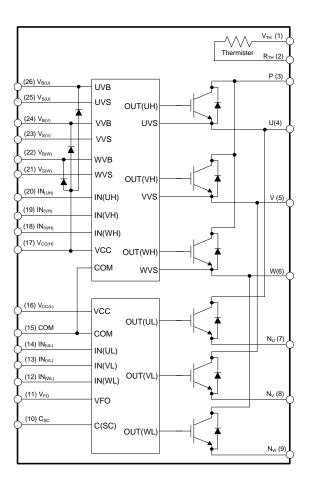


Figure 3. Internal Block Diagram

1st Notes:

- 1. Inverter high-side is composed of three IGBTs, freewheeling diodes, and one control IC for each IGBT.
- 2. Inverter low-side is composed of three IGBTs, freewheeling diodes, and one control IC for each IGBT. It has gate drive and protection functions.
- 3. Inverter power side is composed of four inverter DC-link input terminals and three inverter output terminals.

Absolute Maximum Ratings ($T_J = 25^{\circ}C$, unless otherwise specified.)

Inverter Part

Symbol	Parameter	Conditions	Rating	Unit
V _{PN}	Supply Voltage	Applied between P - N _U , N _V , N _W	450	V
V _{PN(Surge)}	Supply Voltage (Surge)	Applied between P - N _U , N _V , N _W	500	V
V _{CES}	Collector - Emitter Voltage		600	V
I _{0,25}	Output Phase Current	$T_{C} = 25^{\circ}C, \ T_{J} < 150^{\circ}C \ (2nd \text{ Note 1})$	10	А
I _{O,100}	Output Phase Current	$T_{C} = 100^{\circ}C, T_{J} < 150^{\circ}C$ (2nd Note 1)	5	А
I _{pk}	Output Peak Phase Current	T_{C} = 25°C, $T_{J}<150^{\circ}C,$ Under 1 ms Pulse Width	15	A
P _C	Collector Dissipation	T _C = 25°C per Chip	32	W
TJ	Operating Junction Temperature	(2nd Note 2)	- 40 ~ 150	°C

2nd Notes:

1. Sinusoidal PWM at V_{PN} = 300 V, V_{CC} = V_{BS} = 15 V, T_J $\,<\,$ 150 $^\circ\!\!\mathrm{C}$, F_{SW} = 20 kHz, MI = 0.9, PF = 0.8

2. The maximum junction temperature rating of the power chips integrated within the Motion SPM[®] 45 product is 150°C.

Control Part

Symbol	Parameter	Conditions	Rating	Unit
V _{CC}	Control Supply Voltage	Applied between V _{CC(H)} , V _{CC(L)} - COM	20	V
V _{BS}	High - Side Control Bias Voltage	Applied between V _{B(U)} - V _{S(U)} , V _{B(V)} - V _{S(V)} , V _{B(W)} - V _{S(W)}	20	V
V _{IN}	Input Signal Voltage	$\begin{array}{llllllllllllllllllllllllllllllllllll$	-0.3 ~ V _{CC} + 0.3	V
V _{FO}	Fault Output Supply Voltage	Applied between V _{FO} - COM	$-0.3 \sim V_{CC} + 0.3$	V
I _{FO}	Fault Output Current	Sink Current at V _{FO} pin	1	mA
V _{SC}	Current-Sensing Input Voltage	Applied between C _{SC} - COM	$-0.3 \sim V_{CC} + 0.3$	V

Bootstrap Diode Part

Symbol	Parameter	Conditions	Rating	Unit
V _{RRM}	Maximum Repetitive Reverse Voltage		600	V
١ _F	Forward Current	$T_{C} = 25^{\circ}C, T_{J} < 150^{\circ}C$	0.50	A
I _{FP}	Forward Current (Peak)	T_{C} = 25°C, $T_{J}<$ 150°C, Under 1 ms Pulse Width	1.50	A
TJ	Operating Junction Temperature		-40 ~ 150	°C

Total System

Symbol	Parameter	Conditions	Rating	Unit
		$V_{CC} = V_{BS} = 13.5 \sim 16.5 V$ T _J = 150°C, Non-Repetitive, < 2 µs	400	V
T _{STG}	Storage Temperature		-40 ~ 125	°C
V _{ISO}	Isolation Voltage	60 Hz, Sinusoidal, AC 1 Minute, Connect Pins to Heat Sink Plate	2000	V _{rms}

Thermal Resistance

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
R _{th(j-c)Q}	Junction to Case Thermal Resistance	Inverter IGBT Part (per 1 / 6 module)	-	-	3.8	°C / W
R _{th(j-c)F}		Inverter FWDi Part (per 1 / 6 module)	-	-	4.8	°C / W

2nd Notes:

3. For the measurement point of case temperature (T_C), please refer to Figure 2.

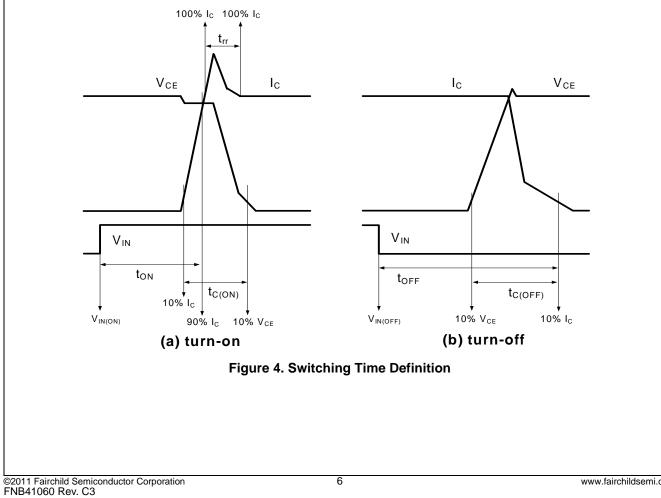
Electrical Characteristics ($T_J = 25^{\circ}C$, unless otherwise specified.)

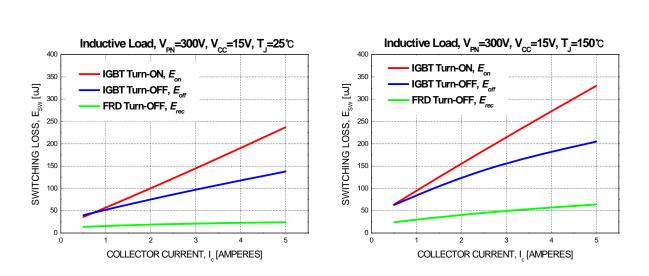
Inverter Part

S	ymbol	Parameter	Cond	itions	Min.	Тур.	Max.	Unit
V	CE(SAT)	Collector - Emitter Saturation Voltage	$V_{CC} = V_{BS} = 15 V$ $V_{IN} = 5 V$	I _C = 5 A, T _J = 25°C	-	1.5	2.0	V
	V _F	FWDi Forward Voltage	$V_{IN} = 0 V$	$I_{F} = 5 \text{ A}, \text{T}_{\text{J}} = 25^{\circ}\text{C}$	-	1.5	2.0	V
HS	t _{ON}	Switching Times	$V_{PN} = 300 \text{ V}, V_{CC} = V_{E}$	_{3S} = 15 V, I _C = 5 A	0.45	0.75	1.25	μS
	t _{C(ON)}		$T_J = 25^{\circ}C$	tive Load	-	0.20	0.45	μS
	t _{OFF}		V _{IN} = 0 V ↔ 5 V, Inductive Load (2nd Note 4)		-	0.70	1.20	μS
	t _{C(OFF)}				-	0.15	0.40	μS
	t _{rr}				-	0.15	-	μS
LS	t _{ON}		$V_{PN} = 300 \text{ V}, V_{CC} = V_{E}$	_{3S} = 15 V, I _C = 5 A	0.35	0.65	1.15	μS
	t _{C(ON)}		$T_J = 25^{\circ}C$	tive Load	-	0.15	0.40	μS
	t _{OFF}		$V_{IN} = 0 V \leftrightarrow 5 V$, Inductive Load (2nd Note 4)	-	0.65	1.15	μS	
	t _{C(OFF)}				-	0.15	0.40	μS
	t _{rr}			-	0.15	-	μS	
I _{CES}		Collector - Emitter Leakage Current	$V_{CE} = V_{CES}$		-	-	1	mA

2nd Notes:

t_{ON} and t_{OFF} include the propagation delay of the internal drive IC. t_{C(ON)} and t_{C(OFF)} are the switching time of IGBT itself under the given gate driving condition internally. For the detailed information, please see Figure 4.







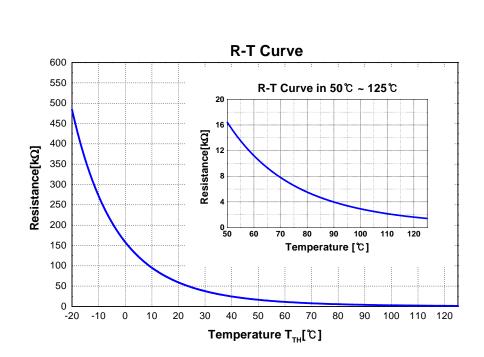
Control Part

Symbol	Parameter	Conditions		Min.	Тур.	Max.	Unit
I _{QCCH}	Quiescent V _{CC} Supply	$V_{CC(H)} = 15 \text{ V}, \text{ IN}_{(UH,VH,WH)} = 0 \text{ V}$	V _{CC(H)} - COM	-	-	0.10	mA
I _{QCCL}	Current	$V_{CC(L)} = 15 \text{ V}, \text{ IN}_{(UL,VL, WL)} = 0 \text{ V}$	V _{CC(L)} - COM	-	-	2.65	mA
I _{PCCH}	Operating V _{CC} Supply Current	$V_{CC(L)}$ = 15 V, f_{PWM} = 20 kHz, duty = 50%, Applied to One PWM Signal Input for High-Side	V _{CC(H)} - COM	-	-	0.15	mA
I _{PCCL}		$V_{CC(L)}$ = 15 V, f_{PWM} = 20 kHz, duty = 50%, Applied to One PWM Sig- nal Input for Low-Side	V _{CC(L)} - COM	-	-	3.65	mA
I _{QBS}	Quiescent V _{BS} Supply Current	V_{BS} = 15 V, IN _(UH, VH, WH) = 0 V	$V_{B(U)} - V_{S(U)}, V_{B(V)} - V_{S(V)}, V_{B(W)} - V_{S(W)}$	-	-	0.30	mA
I _{PBS}	Operating V _{BS} Supply Current	$V_{CC} = V_{BS} = 15 \text{ V}, f_{PWM} = 20 \text{ kHz},$ Duty = 50%, Applied to One PWM Signal Input for High-Side	$\begin{array}{c} V_{B(U)} \text{ - } V_{S(U)}, V_{B(V)} \text{ - } \\ V_{S(V)}, V_{B(W)} \text{ - } V_{S(W)} \end{array}$	-	-	2.00	mA
V _{FOH}	Fault Output Voltage	V_{SC} = 0 V, V_{FO} Circuit: 10 k Ω to 5 V Pull-up		4.5	-	-	V
V_{FOL}		V_{SC} = 1 V, V_{FO} Circuit: 10 k Ω to 5 V	/ Pull-up	-	-	0.5	V
V _{SC(ref)}	Short-Circuit Current Trip Level	V _{CC} = 15 V (2nd Note 5)		0.45	0.50	0.55	V
UV_CCD		Detection level		10.5	-	13.0	V
UV_CCR	Supply Circuit Under-Voltage	Reset level		11.0	-	13.5	V
UV_BSD	Protection	Detection level		10.0	-	12.5	V
UV_BSR		Reset level		10.5	-	13.0	V
t _{FOD}	Fault-Out Pulse Width			30	-	-	μS
V _{IN(ON)}	ON Threshold Voltage	Applied between $\rm IN_{(UH)},~\rm IN_{(VH)},~\rm IN_{(WH)},~\rm IN_{(UL)},~\rm IN_{(VL)},~\rm IN_{(VL)},~\rm IN_{(WL)}$ - COM		-	-	2.6	V
V _{IN(OFF)}	OFF Threshold Voltage			0.8	-	-	V
R _{TH}	Resistance of	@T _{TH} = 25°C, (2nd Note 6)		-	47	-	kΩ
	Thermister	@T _{TH} = 100°C		-	2.9	-	kΩ

2nd Notes:

5. Short-circuit protection is functioning only at the low-sides.

6. T_{TH} is the temperature of thermister itselt. To know case temperature (T_{C}), please make the experiment considering your application.





Bootstrap Diode Part

ſ	Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
F	V _F	Forward Voltage	I _F = 0.1 A, T _C = 25°C	-	2.5	-	V
ſ	t _{rr}	Reverse-Recovery Time	I _F = 0.1 A, T _C = 25°C	-	80	-	ns

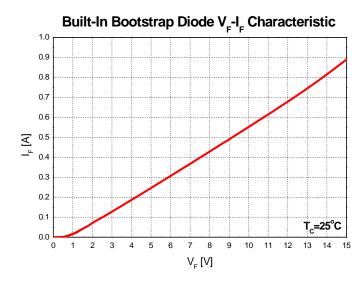


Figure 7. Built-In Bootstrap Diode Characteristic

2nd Notes:

7. Built-in bootstrap diode includes around 15 $\, \Omega \,$ resistance characteristic.

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Recommended Operating Conditions

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
V _{PN}	Supply Voltage	Applied between P - N _U , N _V , N _W	-	300	400	V
V _{CC}	Control Supply Voltage	Applied between V _{CC(H)} , V _{CC(L)} - COM	13.5	15	16.5	V
V_{BS}	High-Side Bias Voltage	Applied between V _{B(U)} - V _{S(U)} , V _{B(V)} - V _{S(V)} , V _{B(W)} - V _{S(W)}	13.0	15	18.5	V
dV _{CC} / dt, dV _{BS} / dt	Control Supply Variation		- 1	-	1	V/μs
t _{dead}	Blanking Time for Preventing Arm-Short	For each input signal	1.5	-	-	μS
f _{PWM}	PWM Input Signal	$-40^{\circ}C < T_{J} < 150^{\circ}C$	-	-	20	kHz
V _{SEN}	Voltage for Current Sensing	Applied between N _U , N _V , N _W - COM (Including Surge-Voltage)	- 4		4	V
P _{WIN(ON)}	Minimun Input Pulse	(2nd Note 8)	0.5	-	-	μs
P _{WIN(OFF)}	Width		0.5	-	-	1

2nd Notes:

8. This product might not make response if input pulse width is less than the recommanded value.

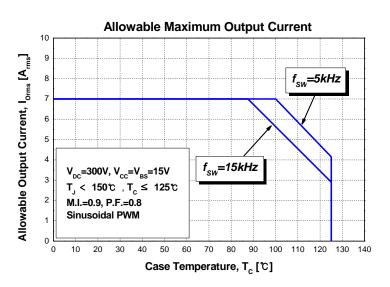
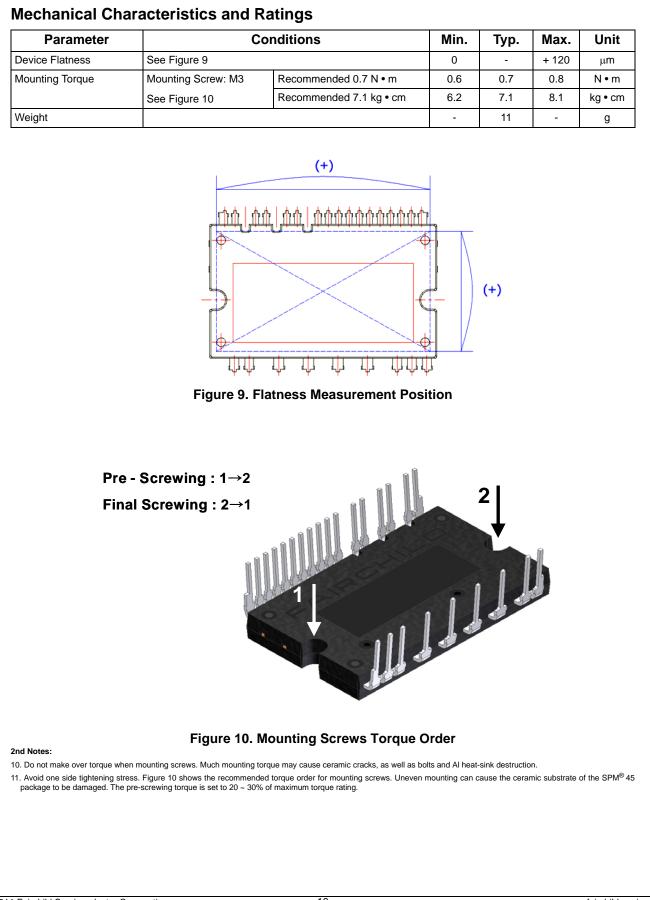


Figure 8. Allowable Maximum Output Current

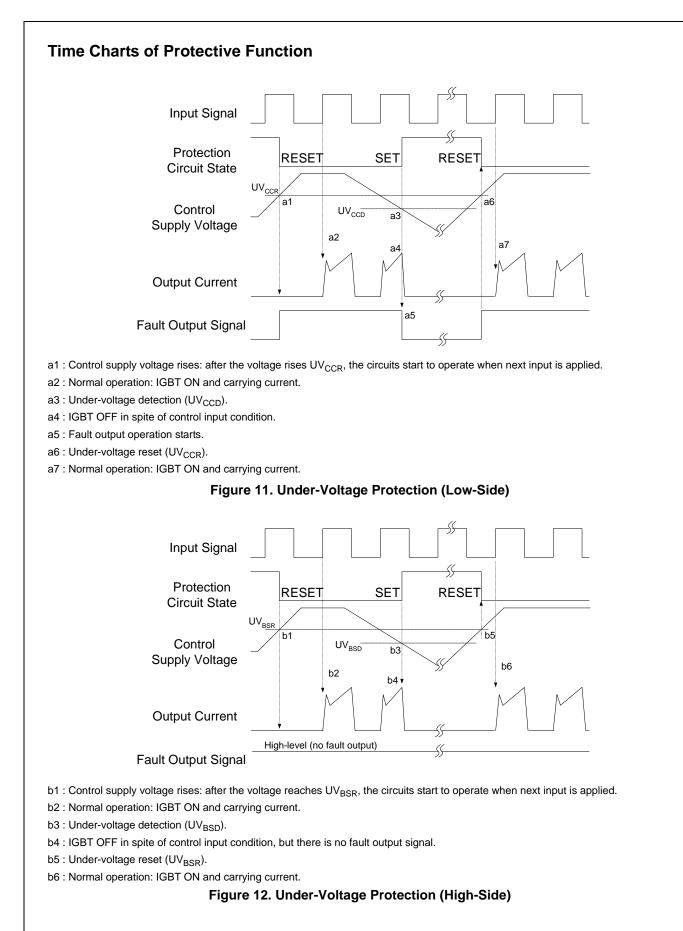
2nd Notes:

9. This allowable output current value is the reference data for the safe operation of this product. This may be different from the actual application and operating condition.

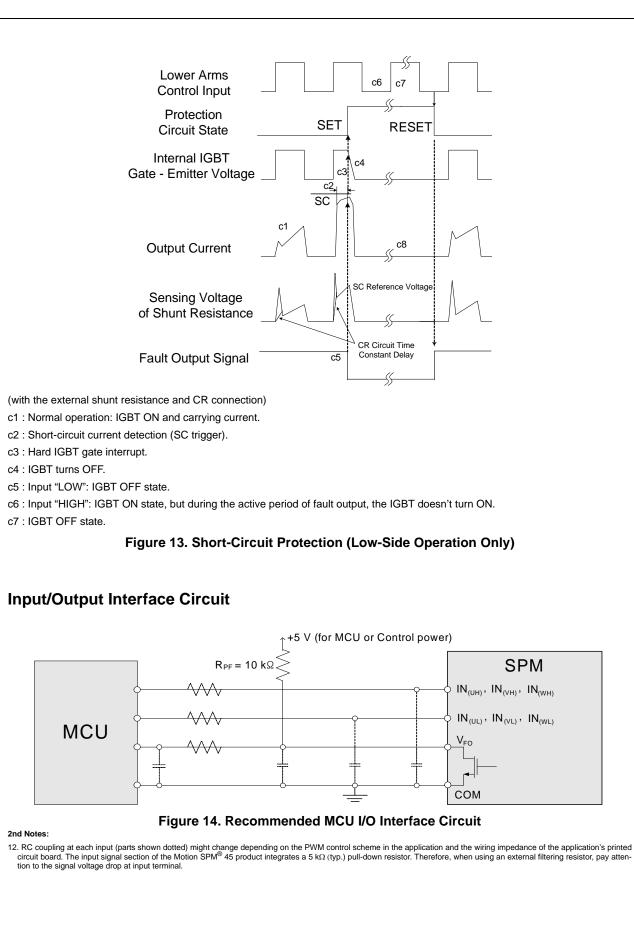


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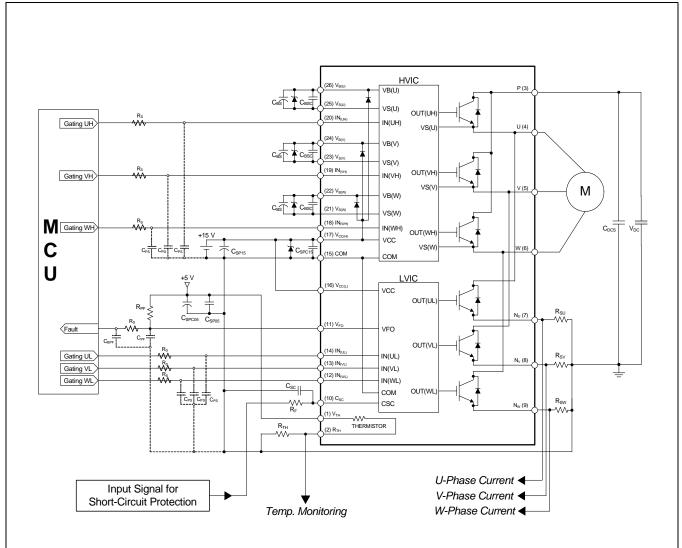
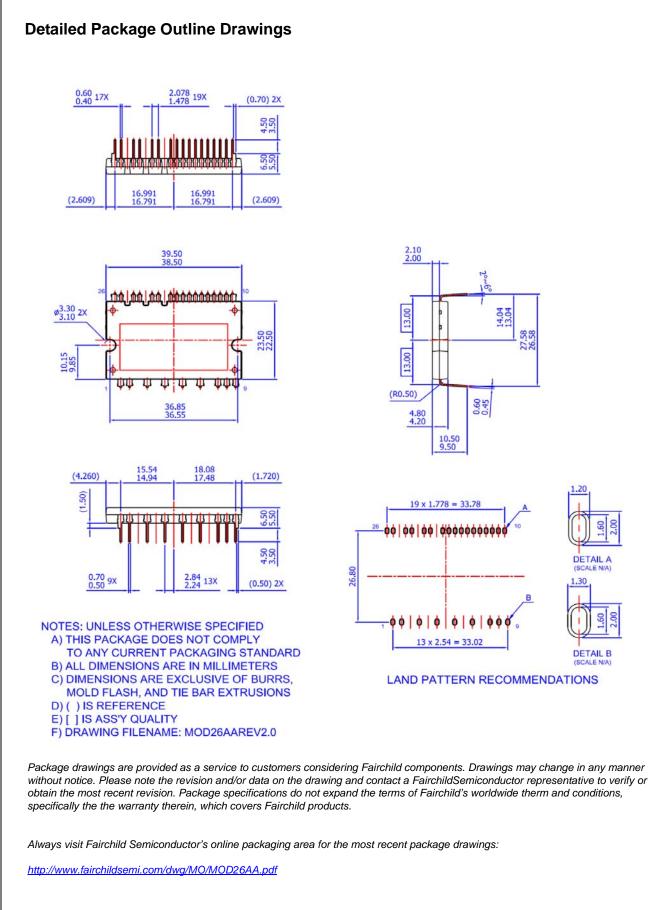


Figure 15. Typical Application Circuit

3rd Notes:

- 1) To avoid malfunction, the wiring of each input should be as short as possible (less than 2 3 cm).
- 2) By virtue of integrating an application-specific type of HVIC inside the Motion SPM[®] 45 product, direct coupling to MCU terminals without any optocoupler or transformer isolation is possible.
- 3) V_{FO} output is open-drain type. This signal line should be pulled up to the positive side of the MCU or control power supply with a resistor that makes I_{FO} up to 1 mA (please refer to Figure 14).
- 4) C_{SP15} of around seven times larger than bootstrap capacitor C_{BS} is recommended.
- 5) Input signal is active-HIGH type. There is a 5 k Ω resistor inside the IC to pull down each input signal line to GND. RC coupling circuits is recommanded for the prevention of input signal oscillation. R_SC_{PS} time constant should be selected in the range 50 ~ 150 ns (recommended R_S = 100 Ω , C_{PS} = 1 nF).
- 6) To prevent errors of the protection function, the wiring around ${\sf R}_{\sf F}$ and ${\sf C}_{\sf SC}$ should be as short as possible.
- 7) In the short-circuit protection circuit, please select the R_FC_{SC} time constant in the range 1.5 ~ 2 $\mu s.$
- 8) The connection between control GND line and power GND line which includes the N_U, N_V, N_W must be connected to only one point. Please do not connect the control GND to the power GND by the broad pattern. Also, the wiring distance between control GND and power GND should be as short as possible.
- 9) Each capacitor should be mounted as close to the pins of the Motion SPM 45 product as possible.
- 10) To prevent surge destruction, the wiring between the smoothing capacitor and the P & GND pins should be as short as possible. The use of a high-frequency non-inductive capacitor of around 0.1 ~ 0.22 µF between the P and GND pins is recommended.
- 11) Relays are used in almost every systems of electrical equipment in home appliances. In these cases, there should be sufficient distance between the MCU and the relays.
- 12) The zener diode or transient voltage suppressor should be adopted for the protection of ICs from the surge destruction between each pair of control supply terminals (recommanded zener diode is 22 V / 1 W, which has the lower zener impedance characteristic than about 15 Ω).
- 13) Please choose the electrolytic capacitor with good temperature characteristic in C_{BS}. Also, choose 0.1 ~ 0.2 μ F R-category ceramic capacitors with good temperature and frequency characteristics in C_{BSC}.
- 14) For the detailed information, please refer to the AN-9070, AN-9071, AN-9072, RD-344, and RD-345.



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